

(Supplemental Document) Interface Engineering of 2D MoS<sub>2</sub> Devices through ALD Oxidant Selection

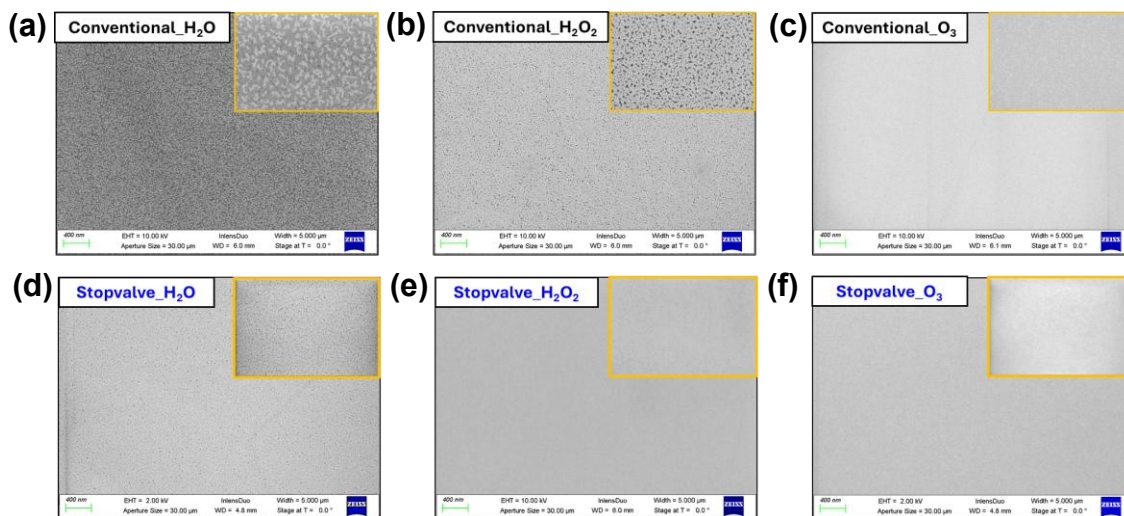


Figure 1. SEM characterization of HfO<sub>2</sub> deposited on MoS<sub>2</sub> by conventional process for (a) H<sub>2</sub>O, (b) H<sub>2</sub>O<sub>2</sub> and (c) O<sub>3</sub> and stop-valve process for (d) H<sub>2</sub>O, (e) H<sub>2</sub>O<sub>2</sub> and (f) O<sub>3</sub>.

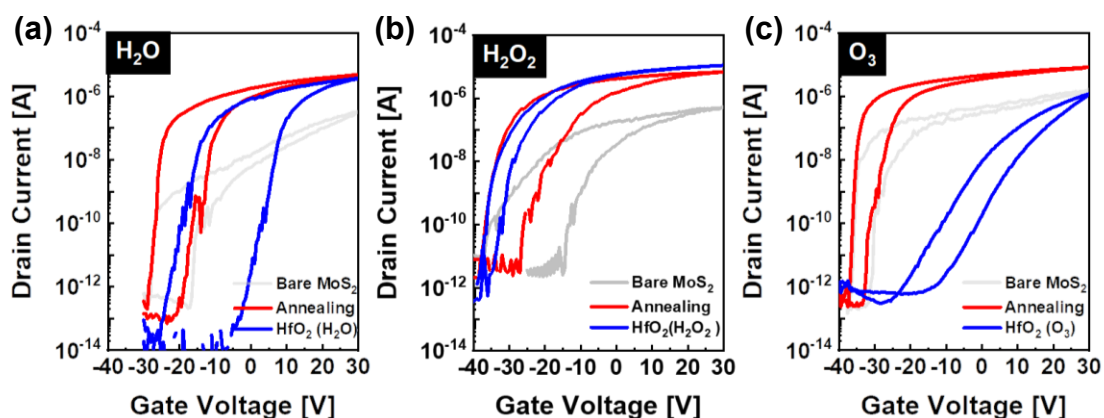


Figure 2. Transfer characteristics after 3nm HfO<sub>2</sub> deposition on MoS<sub>2</sub> devices by (a) H<sub>2</sub>O, (b) H<sub>2</sub>O<sub>2</sub> and (c) O<sub>3</sub> as oxidant.

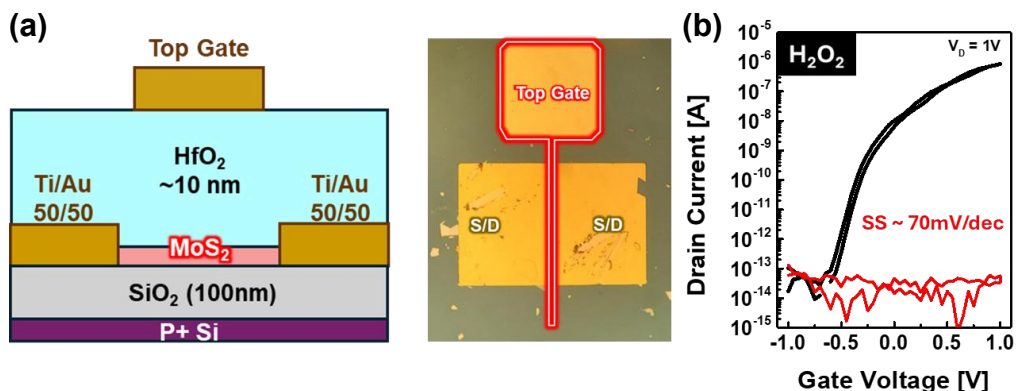


Figure 3. Top-gate structure of 10nm HfO<sub>2</sub>/MoS<sub>2</sub> device (a) Schematic and optical image and (b) transfer characteristic for H<sub>2</sub>O<sub>2</sub>.